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# NATIONAL STANDARD OF THE

# PEOPLE'S REPUBLIC OF CHINA

# GB/T 15879.618-2026

**Mechanical standardization of semiconductor devices - Part 6-18: General rules for the preparation of outline drawings of surface mounted semiconductor device packages - Design guide for ball grid array (BGA)**

半导体器件的机械标准化 第6-18部分：表面安装半导体器件封装外形图绘制的一般规则 焊球阵列封装（BGA）的设计指南

**(English Translation)**

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